

### Am<sub>26</sub>LS<sub>34</sub>

#### **Quad Differential Line Receiver**

### Advanced Micro Devices

#### DISTINCTIVE CHARACTERISTICS

- Meets all requirements of EIA Standards RS-442, RS-423, CCITT V.10 and V.11, and the new party line standard in development under EIA Project Number 1360.
- ±200 mV sensitivity over input voltage range.
- $\pm 150$  mV sensitivity for V<sub>CM</sub> = 0.
- 7 V to + 12 V common mode input voltage range.
- $\blacksquare$  12 k $\Omega$  minimum input impedance.

- Maximum guarantees for tpb skew.
- All AC and DC parameters guaranteed over military and commercial temperature ranges.
- **■** Guaranteed input voltages hysteresis limits.
  - 120mV minimum
  - 300mV maximum
- No internal failsafe.
- Pin compatible with Am26LS32/32B/33

#### GENERAL DESCRIPTION

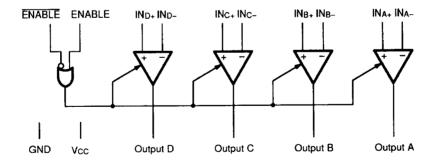
The Am26LS34 is a high performance, quad, differential line receiver. It has higher impedance and higher input voltage hysteresis than the similar Am26LS32B. The Am26LS34 also does not have internal fail-safe to allow greater user flexibility.

Input threshold sensitivity is specified for three different V<sub>CM</sub> ranges. The improved sensitivity, guaranteed hys-

teresis and skew limits allow a more critical analysis of system performance in high noise environments and better system performance capability.

All performance parameters are guaranteed over  $\pm 10\%$  supplies and over the operating temperature range. In addition;  $lo_L$  is specified to 24 mA for easy system bus interfacing.

#### **BLOCK DIAGRAM**



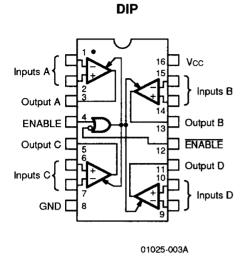
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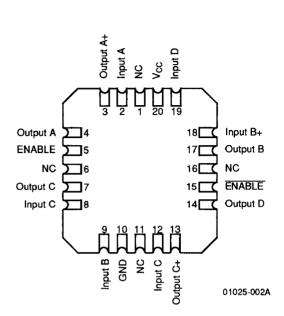
#### **RELATED PRODUCTS**

Part Number	Description
26LS29	Quad Three-State Single Ended RS-423 Line Driver
26LS30	Dual Differential RS-422 Party Line/Quad Single Ended RS-423 Line Driver
26LS32	Quad Differential Line Receiver
26LS33	Quad Differential Line Receiver

Publication# 01025	Rev. B	Amendment/0
issue Date: May 1991		

## CONNECTION DIAGRAMS Top View





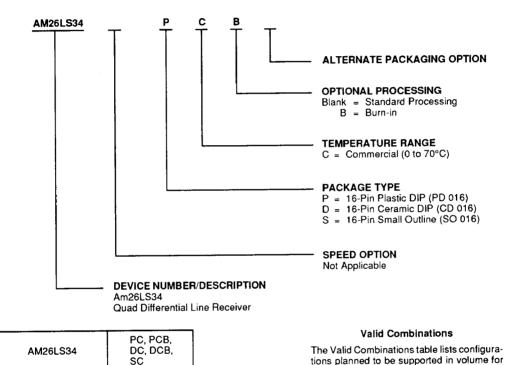
LCC

Note:

Pin 1 is marked for orientation

### ORDERING INFORMATION Standard Products

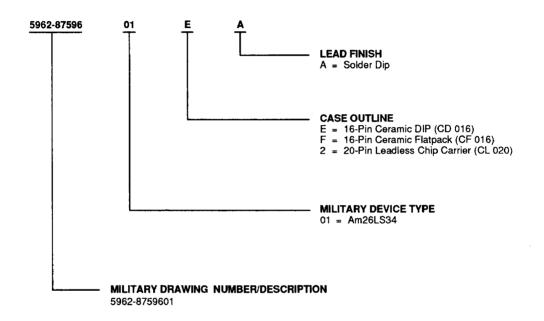
AMD products are available in several packages and operating ranges. The ordering number (Valid Combination) is formed by a combination of:



this device. Consult the local AMD sales office to confirm availability of specific valid combinations, to check on newly released combinations, and to obtain additional data on AMD's standard military grade products.

### ORDERING INFORMATION Standard Military Drawing Products

AMD products for Aerospace and Defense applications are available in several packages and operating ranges. Standard Military Drawing (SMD)/DESC products are fully compliant with MIL-STD-883C requirements. The ordering number for SMD/DESC (Valid Combination) is formed by a combination of:



5962-8759601	EA, FA, 2A
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#### Valid Combinations

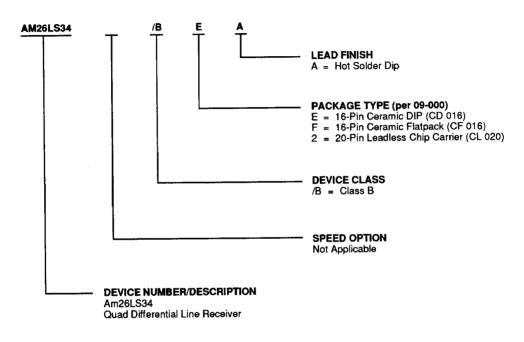
The Valid Combinations table lists configurations planned to be supported in volume for this device. Consult the local AMD sales office to confirm availability of specific valid combinations, to check on newly released combinations, and to obtain additional data on AMD's standard military grade products.

#### **Group A Tests**

Group A tests consist of Subgroups 1, 2, 3, 7, 8, 9, 10, 11.

### ORDERING INFORMATION APL Products

AMD products for Aerospace and Defense applications are available in several packages and operating ranges. APL (Approved Products List) products are fully compliant with MIL-STD-883C requirements. The ordering number (Valid Combination) is formed by a combination of:



AM26LS34 /BEA, /BFA, /B2A

#### **Valid Combinations**

The Valid Combinations table lists configurations planned to be supported in volume for this device. Consult the local AMD sales office to confirm availability of specific valid combinations, to check on newly released combinations, and to obtain additional data on AMD's standard military grade products.

#### **Group A Tests**

Group A tests consist of Subgroups 1, 2, 3, 7, 8, 9, 10, 11.



ABSOLUTE MAXIMUM RA	ATINGS	OPERATING RANGES	
Supply Voltage	7.0 V	Commercial (C) Devices	
Common Mode Voltage	±25 V	Temperature (T <sub>A</sub> )	0°C to +70°C
Differential Input Voltage	±30 V	Supply Voltage (Vcc)	+4.75 V to +5.25 V
Enable Voltage	7.0 V	Military (M) Devices	
Output Sink Current	50mA	Temperature (T <sub>A</sub> )	-55 to +125°C
Storage Temperature Range	-65°C to +165°C	Supply Voltage (Vcc)	+4.5 V to +5.5 V

Stresses above those listed under Absolute Maximum Ratings may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to absolute maximum ratings for extended periods may affect device reliability.

Operating ranges define those limits between which the functionality of the device is guaranteed.

#### DC CHARACTERISTICS over COMMERCIAL operating range unless otherwise specified

Parameter Symbol	Parameter Description	Test Conditions			Min.	Тур.	Max.	Unit
VTH	Differential Input Voltage	Vout = Vol or Voh	0V < Vсм	< + 5 V	-100	±90	+100	
		(Note 5)	-7V ≤ VcM		-200		+200	m∨
VHYST	Input Hysteresis	Vcc = 5.0 V	_15V ≤ Vc	M ≤ +15 V	-400 120	180	+400 300	mV
Rin	Input Resistance	–15 V ≤ Vсм≤ + 15 (One input AC grou		)	12k	20k	40k	Ω
lin	Input Current (Under Test)	Vin = +12 V				0.7	1.0	mA
lin	Input Current (Under Test)	VIN = -7 V				-0.5	-0.8	mA
Vон	Output HIGH Voltage	Vcc = Min., Δ V <sub>IN</sub> =	+1.0 V	12 mA	2.0			٠,,
		VENABLE = 0.8 V	-	1 mA	2.4		3.4	V
Vol	Output LOW Voltage	V <sub>CC</sub> = Min., Δ V <sub>IN</sub> = -1.0 V   I <sub>OH</sub> = 16 mA   V <sub>ENABLE</sub> = 0.8 V   I <sub>OL</sub> = 24 mA				0.4 0.5	>	
VIL	Enable LOW Voltage	(Note 2)				0.8	V	
ViH	Enable HIGH Voltage	(Note 2)		2.0		0.0	V	
Vı	Enable CLAMP Voltage	Vcc = Min., I <sub>IN</sub> = -18 mA				-1.5	V	
Vioc	Open Circuit Input Voltage			2.0		3.0	٧	
lo	Off-State (High impedance) Output Current	Vcc = Max.	Vo = 2.4 V Vo = 0.4 V				50 50	μА
İιμ	Enable LOW Current	Vin = 0.4 V				-0.03	-0.2	mA
IН	Enable HIGH Current	V <sub>IH</sub> = 2.7 V			0.5	20	μΑ	
lı :	Enable Input High Current	Vin = 5.5 V			1	100	μА	
Isc	Output Short Circuit Current	$V_0 = 0 \text{ V,V}_{CC} = \text{Max., } \Delta \text{ V}_{IN} = +1.0 \text{ V}$ (Note 3)		-30	-65	-120	mA	
lcc	Power Supply Current	Vcc = Max., All V <sub>IN</sub> Outputs Disabled	= GND,			52	70	mA

#### Notes:

- 1. All typical values are Vcc = 5.0 V, TA = 25°C.
- 2. Input thresholds are tested during DC tests and may be done in combination with testing of other DC parameters.
- 3. Not more than one output should be shorted at a time. Duration of short circuit test should not exceed one second.
- 4. Rin is not directly tested but is correlated. (See Attachment I)
- 5. Input voltage is not tested directly due to tester accuracy limitations but is tester correlated. (See Attachment II)

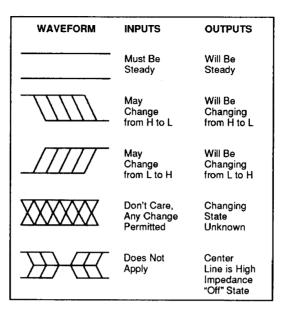
### SWITCHING CHARACTERISTICS over operating ranges unless otherwise specified

Parameter Symbol	Parameter Description	Test Conditions	Comm	Commercial		Military	
			Am26LS34		Am26LS34		
			Min.	Мах.	Min.	Max.	Units
tpun	Propagation Delay, Input to Output			30		30	ns
tphL				30		30	ns
tskew	Propagation Delay Skew, tplh – tphl	C <sub>L</sub> = 50 pF See test circuit		±5		±5	ns
tzı	Output Enable Time, ENABLE to Output			33		33	ns
tzH				22		22	ns
tız	Output Disable Time, ENABLE to Output	C <sub>L</sub> = 5 pF		27		27	ns
thz		See test circuit		27		27	ns

Parameter Symbol	Parameter Description	Test Conditions	Min.	Тур.	Max.	Unit
<b>t</b> PLH	Propagation Delay,			18	24	ns
tpHL	Input to Output			20	24	ns
tskew	Propagation Delay Skew,	$C_L = 50 \text{ pF}$ See test circuit		2	4	ns
tzL	Output Enable Time, ENABLE to Output			16	22	ns
tzн				10	16	ns
<b>1</b> LZ	· · · · · · · · · · · · · · · · · · ·	C. EnE		11	18	ns
tнz	Output Disable Time, ENABLE to Output	C <sub>L</sub> = 5 pF See test circuit		13	18	ns
Tristate Dela	ys For Enable Bar					<b>,</b>
Parameter	Parameter Description	Test Conditions	Min.	Typ.	Max.	Unit

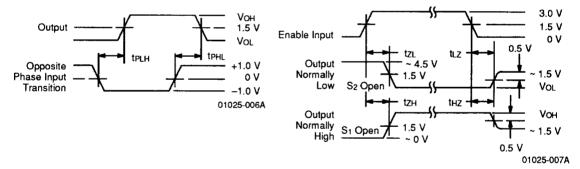
Parameter Symbol	Parameter Description	Test Conditions	Min.	Тур.	Max.	Unit
tрzн	Propagation Delay From ENABLE BAR to Output	$\begin{aligned} C_L &= 50 \text{ pF, } R_{L1} = 1 \text{ K}\Omega, \\ R_{L2} &= 280 \Omega \end{aligned}$			26	ns
tpzL	Propagation Delay From ENABLE BAR to Output	$\begin{aligned} \text{C}_{\text{L}} &= 50 \text{ pF, R}_{\text{L1}} = \text{1 K}\Omega, \\ \text{R}_{\text{L2}} &= 280 \ \Omega \end{aligned}$			33	ns
t <sub>PHZ</sub>	Propagation Delay From ENABLE BAR to Output	$C_L$ = 5 pF, $R_{L1}$ =1 K $\Omega$ , $R_{L2}$ = 280 $\Omega$			20	ns
t <sub>PLZ</sub>	Propagation Delay From ENABLE BAR to Output	$C_L$ = 5 pF, $R_{L1}$ =1 K $\Omega$ , $R_{L2}$ = 280 $\Omega$			20	ns
tрzн	Propagation Delay From ENABLE BAR to Output	$C_L$ = 50 pF, $R_{L1}$ =1 K $\Omega$ , $R_{L2}$ = 280 $\Omega$			39	ns
<b>t</b> PZL	Propagation Delay From ENABLE BAR to Output	$C_L$ = 50 pF, $R_{L1}$ =1 K $\Omega$ , $R_{L2}$ = 280 $\Omega$			49	ns
tpHZ	Propagation Delay From ENABLE BAR to Output	$C_L$ = 5 pF, $R_{L1}$ =1 $K\Omega$ , $R_{L2}$ = 280 $\Omega$			30	ns
<b>t</b> PLZ	Propagation Delay From ENABLE BAR to Output	$C_L = 5 \text{ pF}, R_{L1} = 1 \text{ K}\Omega,$ $R_{L2} = 280 \Omega$			30	ns

#### **KEY TO SWITCHING WAVEFORMS**



KS000010

#### **SWITCHING WAVEFORMS**



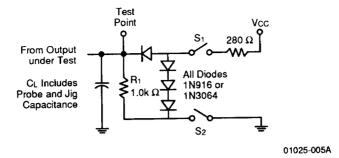
Propagation Delay (Notes 1 and 3)

Enable And Disable Times (Notes 2 and 3)

#### Notes:

- 1. Diagram shown for ENABLE LOW.
- 2. S1 and S2 of Load Circuit are closed except where shown.
- 3. Pulse Generator Rate  $\leq 1.0$  MHz;  $Z_0 = 50\Omega$ ;  $t_r$ ;  $t_f \leq 2.5$ ns.

#### SWITCHING TEST CIRCUIT



**Three-State Outputs** 

#### **ATTACHMENT I**

### Am26LS32/32B/33/34 Input Resistance and Input Current

Input resistance measurement for differential inputs on line receivers are generally not measured directly. Instead they are correlated to an input current measurement and to the process resistor temperature coefficient. The assumptions made include 1) Process resistor temperature coefficient is known and 2) The open input bias voltage for the input is known or measured within the same test sequence.

Under the above assumptions R<sub>IN</sub> can be correlated to the input current measured. The expression

$$R_{IN} = \frac{(V_{ICM} - V_{IN}) (R_T)}{(I_{IN}) (R25)}$$

where V<sub>ICM</sub> is the open input bias voltage of the Line Receiver. When applying this correlation to the 26LS32 die, the following criteria have been set.

- 1) VICM and IIN are the values screened at wafer sort.
- 2) Temperature coefficients are for 800 ohm/square which gives 0.96 at 0°C and 0.93 at -55°C.

When setting limits, characterized values for  $V_{ICM}$  have been used instead of the test programmed limit value.  $R_{IN}$  (dif) is  $R_{IN}$  (dif) = 2  $R_{IN}$ .

For the Am26LS32/32B/33/34

Rin Min. = 
$$\frac{(2.56 - 15) \ 0.96}{\text{lin (Max.)}}$$
 = 16.8/lin (Max.) Comm.,

and

RIN Min. = 16.3/lin (Max.) Mil.

### **Worst Case Measurement for Input Current**

Two considerations have been used to determine the test condition for input current of the data path for the Am26LS32 Line Receiver.

- 1) Input current is tested on the 26LS32 with the pin under test at one end of the range (+15 V for example) and the untested pin at the opposite extreme of the input range under test. If both pins were at the same test voltage the internal bias generator would have a lower output voltage for tests at -15 V V<sub>IN</sub> and a higher output voltage at +15 V V<sub>IN</sub>. This would produce test currents less than maximum.
- For the 26LS32, breakdown of the differential inputs is the primary failure to the data sheet specification. Hence, both breakdown voltage and input current are tested during the input current tests.

# ATTACHMENT II Test Documentation For Am26LS32/32B/34 V<sub>TH</sub>

Input threshold (VTH) for the Am26LS32/32B/34 is described by the equation,

 $V_{TH} = (N+1) (1+R1/R) K^*T/Q ((1+Rh/(m (Rc+Rh))) /(1-Rh/(M(Rc+Rh))).$ 

Where N+1 is the attenuator ratio, R1/R is the attenuator ratio mismatch, M is the ratio of the input stage current to hysteresis stage current, and Rh and Rc are input stage loads. For Am26LS32 – 34 devices which pass function tests, VoH and VoL tests, thresholds for all inputs within the operating range of the circuit.

The Test system is unable to force input thresholds within the accuracy required for the Am26LS32 – 34 specifications. Figure 1 plots the expected values for V<sub>TH</sub>, the worst case values at 25°C and 155°C. Also shown are the test values for V<sub>TH</sub> at the -1.5 V input (V<sub>IN</sub>). In addition, the test voltage at -7 V V<sub>IN</sub> is shown.

For the figure it is seen that the worst case value for the test limit shown would be +/-165 mV, where +/-102 mV is expected for process parameters and the equation for V<sub>TH</sub>. Further the 25 mV negative guardband used for -7 V testing is less than half the machine uncertainty of 60 mV.

When QA testing for Am26LS32/32B/34 is done, thresholds are screened for Vc $_{\rm M}$  other than -1.5 V. These additional tests are considered functional tests only, and the precision threshold tests which insure compliance with data sheet limits are those tests performed where the inputs are tested near -1.5 V.

The actual threshold tests are done as a sequence where a setup is performed which preconditions the DUT to a logic one state, then the threshold correlation for a logic zero is tested followed by a threshold correlation for logic one to complete the sequence. The limit values for the setup (Vt SET), logic zero test (Vt "-"), and logic one test (Vt "+") are listed under VTH for supply value of 5.0 V.

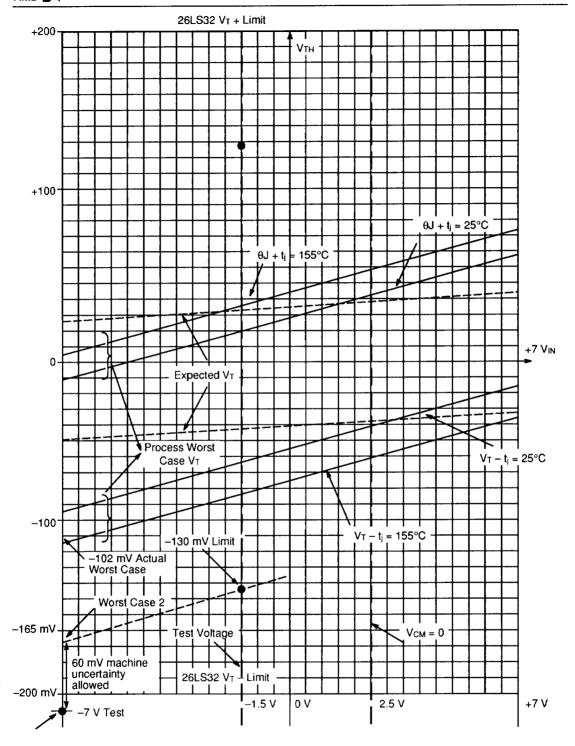


Figure 1. 26LS32 Input Threshold V<sub>T</sub> vs. Input Voltage V<sub>IN</sub>